DECLARATION FOR U.S. PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

ADHESIVE FILM, FLEXIBLE METAL-CLAD LAMINATE INCLUDING THE SAME WITH IMPROVED DIMENSIONAL STABILITY, AND PRODUCTION METHOD THEREFOR

the specification	on of which is attached hereto un	iless the following is ch	ескеа	
was filed o International A	nas United States Application Number PCT/JP200	ation Number and 4/019850 and was amer	d was filed on 28/December/aded on(if applicable).	2004 as PCT
I hereby state to claim(s), as an	hat I have reviewed and underst nended by any amendment refer	and the contents of the red above.	above-identified specification	, including the
I acknowledge Federal Regula	the duty to disclose information ations, § 1.56.	which is material to pa	tentability as defined in Title	37, Code of
application(s) t	foreign priority benefits under for patent or inventor's certification's certificate having a filing of	te listed below and have	also identified below any for	reign application for
				Priority Claimed
(List prior foreign applications. See	2004-006144	JAPAN	13/January/2004	⊠ Yes □ No
note A)	(Number)	(Country)	(Day/Month/Year Filed)	
	(Number)	(Country)	(Day/Month/Year Filed)	☐ Yes ☐ No
	(Number)	(Country)	(Day/Mondo Fear Fried)	
				Yes No
	(Number)	(Country)	(Day/Month/Year Filed)	
				Yes No
	(Number)	(Country)	(Day/Month/Year Filed)	
(See note B)	See attached list for additional	prior foreign application	ons	
and, insofar as application in duty to disclos § 1.56 which	the benefit under Title 35, Unstitute the subject matter of each of the manner provided by the firme information which is material became available between the firm application.	the claims of this appli st paragraph of Title 3: to patentability as defin	ication is not disclosed in the states. Code, § 112 ed in Title 37. Code of Feder	e prior United States 2, I acknowledge the ral Regulations.
	app		Stat	us
(List prior U.S. Applications)			☐ Patented ☐ Pend	ling Abandoned
	(Application Serial No.)	(Filing Date)		
			Patented Pend	ling
	(Application Serial No.)	(Filing Date)		
		(Eili Diri	Patented Pend	ling Abandoned
	(Application Serial No.)	(Filing Date)		
		(Eili - D	Patented Pend	ling
	(Application Serial No.)	(Filing Date)		

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

Customer Number: 38834

Please direct all communications to the following address:

Westerman, Hattori, Daniels & Adrian, LLP 1250 Connecticut Avenue, N.W., Suite 700, Washington, D.C. 20036

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

See note C)	Full name of sole or	first inventor (given name, family name)	Tak	Takashi KIKUCHI		
	Inventor's signature	Hakashi Kikuchi	Date 29.	Jun. 2006		
	Residence	Shiga, Japan	Citizenship	Japan		
	Post Office Address					
	Full name of second	inventor (given name, family name)	Hi	royuki TSUJI		
	Inventor's signature	Mumber Don	Date 29	Jun, 2006		
	Residence	Shiga, Japan	Citizenship '	Japan'		
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	Full name of third in	ventor (given name, family name)	Hisay:	asu KANESHIRO		
	Inventor's signature Residence	Hisayasu Kaneshiro	Citizenship	Jun, 2006		
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	Full name of fourth inventor's signature Residence Post Office Address	inventor (given name, family name)	Date Citizenship			
	Inventor's signature	ventor (given name, family name)	Date			
	Residence Post Office Address		Citizenship _			
	Full name of sixth in	aventor (given name, family name)				
	Inventor's signature		Date			
	Residence		Citizenship			
	Post Office Address					

NOTES

- A. Please list all foreign applications relating to the invention and check block "yes" or "no".
- B. If more than 4 prior foreign applications, please check this box and attach a sheet listing the remaining prior foreign applications.
- C. For residence in the U.S., indicate <u>city and state</u>, for residence outside the U.S., indicate <u>city and country</u>. The "Post Office Address" must be an address acceptable by a Post Office for delivery of mail.